As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

| | | | | | original, first and joint inventor (if plura |
|---|--|---------------------------------|--|-------------------------------|--|
| | ow) of the subject matter which | | - | - | |
| | F MANUFACTURING E, AND IMAGE FO | | | | LECTRON SOURCE |
| | | | | | APPARATUS FOR SOURCE SUBSTRATE |
| THINOTHET | DRING EBECTRONI | C DLVI | CL AND ED | ECTRON | SOURCE SUBSTRATE |
| | | | | | |
| the specification of | | | | | 2000 as United States Application |
| | tional Application No. | PC | T/JP00/01 | 024 | |
| and was amended or | 1 | | | | (if applicable) |
| I hereby statemented by any ame | te that I have reviewed and un endment referred to above. | derstand the | contents of the abo | ove-identified | specification, including the claims, as |
| I acknowled | ge the duty to disclose informat | ion which is | material to patentab | ility as defin | ed in 37 CFR §1.56. |
| inventor's certificate listed below and ha | e, or § 365(a) of any PCT inter | national appli reign applica | cation which desigr tion for patent or is | ates at least | any foreign application(s) for patent one country other than the United States ifficate, or PCT international application |
| Country | Application No. | | Filed (Day/Mo./) | (r.) | (Yes/No) Priority Claimed |
| JAPAN | 11-047095 | 2.4 | February | | Yes |
| I hereby an | noint the practitioners associated | l with the firm | and Customer No. | | d below to prosecute this application an |
| to transact all busin | ness in the Patent and Tradema with that Customer Number: | rk Office con | nected therewith, a | nd direct that | t all correspondence be addressed to the |
| | FITZPA | | LLA, HARPER & r Number: 05514 | SCINTO | |
| made are punishable | to be true; and further that these | statements wo oth, under Sec | vere made with the stion 1001 of Title 1 | knowledge th 8 of the Unit | all statements made on information an at willful false statements and the like s ed States Code and that such willful fals |
| Full Name of Sole | or First Inventor | Seiji | MISHIMA | | |
| Inventor's signature | Sein | mis | hima | | |
| Date Octob | er 13, 2000 | c | itizen/Subject of | J. | APAN |
| Residence ROC | • | | s, 23-14, | | igaoka 4-chome, |
| Zama-shi | , Kanagawa 228 | -0001 | Japan | | |
| | c/o Canon Ka | | | | |
| | imomaruko 3-ch | | | okvo 1 | 46-8501 Japan |
| <u> </u> | IIIIOMATUKO 5 CII | ome, o | ilca-ku, i | JRYO. I | 40-0301 Dapan |
| Full Name of Secon | nd Joint Inventor, if any | | | | |
| | ignature | | | | |
| | • | | | - | |
| | | | | - | |
| Kesidence | _ | | | | |
| | | | | | |
| Post Office Address | S | | | | - |